VISHAY

Thin Film Microwave Resistor



Product may not be to scale

The MIF resistor chips on alumina are designed with low shunt capacitance. Resistor geometrics are compatible with strip lines, making them ideally suited for microwave circuits. These chips are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The MIFs are 100 % electrically tested and visually inspected to MIL-STD-883.

FEATURES

Wire bondable

Small single chip size: 0.016 x 0.020 inches
 Microwave resistance range: 20 Ω to 100 Ω

• Overall resistance range: 20Ω to $2 k\Omega$

Alumina substrate

• Low stray capacitance: < 0.2 pF

• Resistor material: Tantalum nitride, self passivating

• Moisture resistant

• Power: 50 mW

· High frequency

APPLICATIONS

Vishay EFI MIF chip resistors provide excellent high frequency response and are ideally suited for prototyping. Typical application areas are:

Amplifiers

Oscillators

Attenuators

Couplers

Filters

TEMPERATURE COEFFICIENT OF RESISTANCE, VALUES AND TOLERANCES				
Resistance Range	20 Ω to 100 Ω			
Tolerance	± 1 %, ± 5 %, ± 10 %, ± 20 % standard			
TCR	± 100 ppm/°C			

STANDARD ELECTRICAL SPECIFICATIONS				
PARAMETER				
Noise, MIL-STD-202, Method 308	- 20 dB typ.			
Moisture Resistance, MIL-STD-202, Method 106	± 0.5 % max. Δ <i>R</i> / <i>R</i>			
Stability, 1000 h, + 125 °C, 25 mW	± 0.5 % max. Δ <i>R/R</i>			
Operating Temperature Range	- 55 °C to + 125 °C			
Thermal Shock, MIL-STD-202, Method 107, Test Condition F	± 0.25 % max. Δ <i>R</i> / <i>R</i>			
High Temperature Exposure, + 150 °C, 1000 h	± 0.5 % max. Δ <i>R</i> / <i>R</i>			
Dielectric Voltage Breakdown	400 V			
Insulation Resistance	10 ¹² min.			
Operating Voltage	100 V max.			
DC Power Rating at + 70 °C (Derated to Zero at 150 °C)	50 mW max.			
5 x Rated Power Short-Time Overload, + 25 °C, 5 s	± 0.25 % max. Δ <i>R</i> / <i>R</i>			

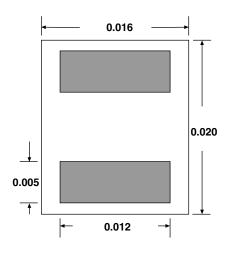


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DIMENSIONS in inches

SCHEMATIC





MECHANICAL SPECIFICATIONS in inches				
PARAMETER				
Chip Size	0.016 x 0.020 ± 0.003 (0.40 x 0.5 ± 0.076 mm)			
Chip Thickness	$0.010 \pm 0.001 \ (0.25 \pm 0.025 \ mm)$			
Chip Substrate Material	99.6 % alumina, 2 - 4 microinch finish			
Resistor Material	Tantalum nitride, self passivating			
Bonding Pad Size	0.005 x 0.012 (0.125 x 0.30 mm)			
Number of Pads	2			
Pad Material	25 kÅ minimum gold standard			
Backing	None			

Options:

Terminations: Aluminum/solder Gold back for solder die attach

5 mil chip thickness

Contact Applications Engineer

ORDERING INFORMATION							
Example: 100 % visualled, 50 Ω , \pm 10 %, \pm 100 ppm/°C TCR, gold pads, class H visual inspection							
W INSPECTION/ PACKAGING W = 100 % visually inspected parts in matrix trays per MIL-STD-883 X = Sample, visually inspected parts loaded in matrix trays (4 % AQL)	MIF PRODUCT FAMILY	002 PROCESS CODE	5000 RESISTANCE VALUE Use first 4 digits significant digits of the resistance	B MULTIPLIER CODE B = 0.01 A = 0.1 0 = 1	K TOLERANCE CODE F = 1.0 % G = 2.0 % H = 2.5 % J = 5.0 % K = 10 % M = 20 %		



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